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- Member of the Texas Instruments Widebus™ Family
- EPIC<sup>™</sup> (Enhanced-Performance Implanted CMOS) Submicron Process
- Typical V<sub>OLP</sub> (Output Ground Bounce)
  < 0.8 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot)
  2 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- I<sub>off</sub> Supports Partial-Power-Down-Mode Operation
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V<sub>CC</sub>)

- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- Packaged in Plastic Fine-Pitch Ball Grid Array Package

#### description

This 32-bit (dual-octal) noninverting bus transceiver is designed for 1.65-V to 3.6-V V<sub>CC</sub> operation.

The SN74LVCH32245A is designed for asynchronous communication between data buses. The control-function implementation minimizes external timing requirements.

This device can be used as four 8-bit transceivers, two 16-bit transceivers, or one 32-bit transceiver. It allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable  $(\overline{OE})$  input can be used to disable the device so that the buses are effectively isolated.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74LVCH32245A is characterized for operation from -40°C to 85°C.

## FUNCTION TABLE (each 8-bit section)

INP	UTS	OPERATION					
OE	DIR	OFERATION					
L	L	B data to A bus					
L	Н	A data to B bus					
Н	X	Isolation					



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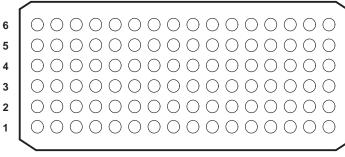
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### SN74LVCH32245A 32-BIT BUS TRANSCEIVER WITH 3-STATE OUTPUTS

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#### GKE PACKAGE (TOP VIEW)

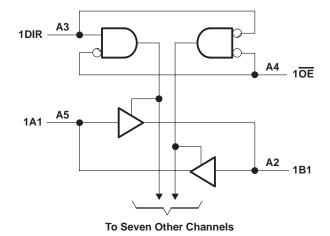


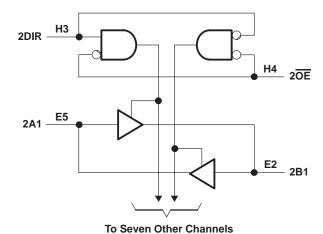
#### A B C D E F G H J K L M N P R T

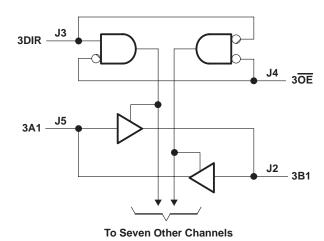
### terminal assignments

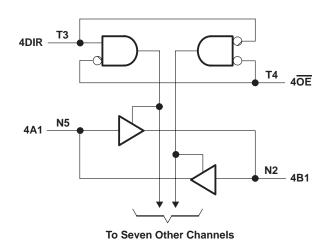
6	1A2	1A4	1A6	1A8	2A2	2A4	2A6	2A7	3A2	3A4	3A6	3A8	4A2	4A4	4A6	4A7
5	1A1	1A3	1A5	1A7	2A1	2A3	2A5	2A8	3A1	3A3	3A5	3A7	4A1	4A3	4A5	4A8
4	1 <mark>OE</mark>	GND	Vcc	GND	GND	Vcc	GND	2OE	3 <mark>OE</mark>	GND	Vcc	GND	GND	VCC	GND	4OE
3	1DIR	GND	Vcc	GND	GND	Vcc	GND	2DIR	3DIR	GND	Vcc	GND	GND	Vcc	GND	4DIR
2	1B1	1B3	1B5	1B7	2B1	2B3	2B5	2B8	3B1	3B3	3B5	3B7	4B1	4B3	4B5	4B8
1	1B2	1B4	1B6	1B8	2B2	2B4	2B6	2B7	3B2	3B4	3B6	3B8	4B2	4B4	4B6	4B7
	Α	В	С	D	E	F	G	Н	J	K	L	М	N	Р	R	T

#### logic diagram (positive logic)









absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub> 0.5 V to 6.5 V
Input voltage range, V <sub>I</sub> : (see Note 1)
Voltage range applied to any output in the high-impedance or power-off state, VO
(see Note 1)
Voltage range applied to any output in the high or low state, VO
(see Notes 1 and 2)
Input clamp current, $I_{IK}$ ( $V_I < 0$ )
Output clamp current, $I_{OK}$ ( $V_O < 0$ )
Continuous output current, I <sub>O</sub> ±50 mA
Continuous current through each V <sub>CC</sub> or GND
Package thermal impedance, θ <sub>JA</sub> (see Note 3)
Storage temperature range, T <sub>stq</sub> –65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. The value of V<sub>CC</sub> is provided in the recommended operating conditions table.
- 3. The package thermal impedance is calculated in accordance with JESD 51.



### SN74LVCH32245A **32-BIT BUS TRANSCEIVER WITH 3-STATE OUTPUTS**

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### recommended operating conditions (see Note 4)

			MIN	MAX	UNIT	
Vcc	Supply voltage	Operating	1.65	3.6	V	
vCC	Su <b>pp</b> ly voltage	1.5		1 °		
		V <sub>CC</sub> = 1.65 V to 1.95 V	0.65 × V <sub>CC</sub>			
$V_{IH}$	High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2			
		V <sub>CC</sub> = 1.65 V to 1.95 V		0.35 × V <sub>CC</sub>		
$V_{IL}$	Low-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8		
٧ <sub>I</sub>	Input voltage	•	0	5.5	V	
v <sub>O</sub>	Outrot valta as	High or low state	0	VCC	V	
	Output voltage	3 state	0	5.5	V	
		V <sub>CC</sub> = 1.65 V		-4		
1	High-level output current	V <sub>CC</sub> = 2.3 V		-8	mA	
ЮН		V <sub>CC</sub> = 2.7 V		-12	IIIA	
		V <sub>CC</sub> = 3 V		-24		
		V <sub>CC</sub> = 1.65 V		4		
1	Laveland autout among	V <sub>CC</sub> = 2.3 V		8		
IOL	Low-level output current	V <sub>CC</sub> = 2.7 V		12	mA	
		V <sub>CC</sub> = 3 V		24		
Δt/Δν	Input transition rise or fall rate		5	ns/V		
TA	Operating free-air temperature		-40	85	°C	

NOTE 4: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PAF	RAMETER	TEST C	CONDITIONS	VCC	MIN	TYP†	MAX	UNIT			
		I <sub>OH</sub> = -100 μA		1.65 V to 3.6 V	V <sub>CC</sub> -0.	2					
		$I_{OH} = -4 \text{ mA}$	1.65 V	1.2							
Vон	Vall	I <sub>OH</sub> = -8 mA		2.3 V	1.7			V			
VOH		I <sub>OH</sub> = -12 mA		2.7 V	2.2			v			
		10H = 12111A		3 V	2.4						
		$I_{OH} = -24 \text{ mA}$		3 V	2.2						
		I <sub>OL</sub> = 100 μA		1.65 V to 3.6 V			0.2				
		$I_{OL} = 4 \text{ mA}$		1.65 V			0.45				
VOL		$I_{OL} = 8 \text{ mA}$	2.3 V			0.7	7 V				
		I <sub>OL</sub> = 12 mA	2.7 V	.7 V (			]				
		I <sub>OL</sub> = 24 mA	3 V			0.55					
IĮ	Control inputs	$V_I = 0 \text{ to } 5.5 \text{ V}$		3.6 V			±5	μΑ			
		V <sub>I</sub> = 0.58 V	1.65 V	25							
		V <sub>I</sub> = 1.07 V	1.05 V	-25							
		V <sub>I</sub> = 0.7 V	2.3 V	45			μА				
I <sub>I(hold)</sub>		V <sub>I</sub> = 1.7 V	2.5 V	-45							
		V <sub>I</sub> = 0.8 V	3 V	75							
		V <sub>I</sub> = 2 V	3 4	-75							
		$V_{I} = 0 \text{ to } 3.6 \text{ V}^{\ddagger}$	3.6 V			±500					
l <sub>off</sub>		$V_I$ or $V_O = 5.5 V$	0			±10	μΑ				
I <sub>OZ</sub> §		$V_0 = 0 \text{ to } 5.5 \text{ V}$		3.6 V			±10	μΑ			
Icc		$V_I = V_{CC}$ or GND	I <sub>O</sub> = 0	3.6 V				μΑ			
		$3.6 \text{ V} \le \text{V}_{\text{I}} \le 5.5 \text{ V}^{\P}$	10 - 0	3.0 V			20	μΛ			
Δl <sub>CC</sub>		One input at $V_{CC}$ – 0.6 V, Other inputs at $V_{CC}$ or GND		2.7 V to 3.6 V			500	μΑ			
Ci	Control inputs	$V_I = V_{CC}$ or GND		3.3 V		5		pF			
C <sub>io</sub>	A or B ports	$V_O = V_{CC}$ or GND		3.3 V		7.5		pF			

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

# switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 1.8 V ± 0.15 V		V <sub>CC</sub> = 2.5 V ± 0.2 V		V <sub>CC</sub> = 2.7 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		UNIT
	(1141 01)	(0011 01)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
<sup>t</sup> pd	A or B	B or A	#	#	#	#		4.7	1	4	ns
t <sub>en</sub>	ŌĒ	A or B	#	#	#	#		6.7	1.5	5.5	ns
<sup>t</sup> dis	ŌE	A or B	#	#	#	#		7.1	1.5	6.6	ns
t <sub>sk(o)</sub>										1.5	ns

<sup>#</sup>This information was not available at the time of publication.



<sup>‡</sup> This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

<sup>§</sup> For I/O ports, the parameter IOZ includes the input leakage current, but not I<sub>I</sub>(hold).

<sup>¶</sup> This applies in the disabled state only.

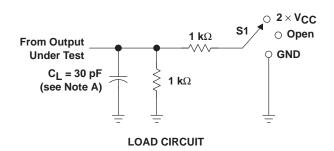
 $<sup>\</sup>parallel$  Skew between any two outputs of the same package switching in the same direction

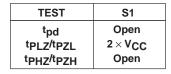
#### operating characteristics, T<sub>A</sub> = 25°C

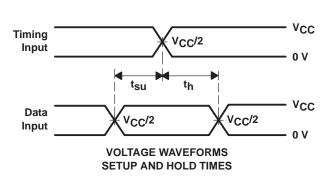
	PARAMETER	TEST	V <sub>CC</sub> = 1.8 V	V <sub>CC</sub> = 2.5 V	V <sub>CC</sub> = 3.3 V	UNIT	
PARAMETER			CONDITIONS	TYP	TYP	TYP	J ONT
<u> </u>	Power dissipation capacitance	Outputs enabled	f = 10 MHz	†	†	40	pF
C <sub>pd</sub>	per transceiver	Outputs disabled	1 = 10 WHZ	†	†	4	pΓ

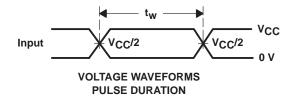
<sup>†</sup> This information was not available at the time of publication.

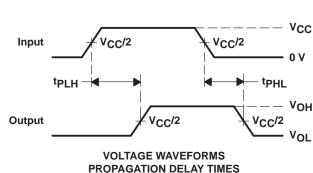
#### PARAMETER MEASUREMENT INFORMATION $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$

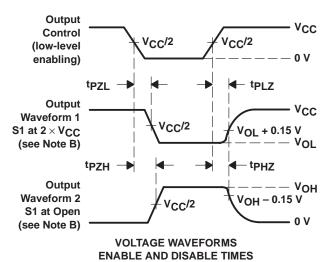












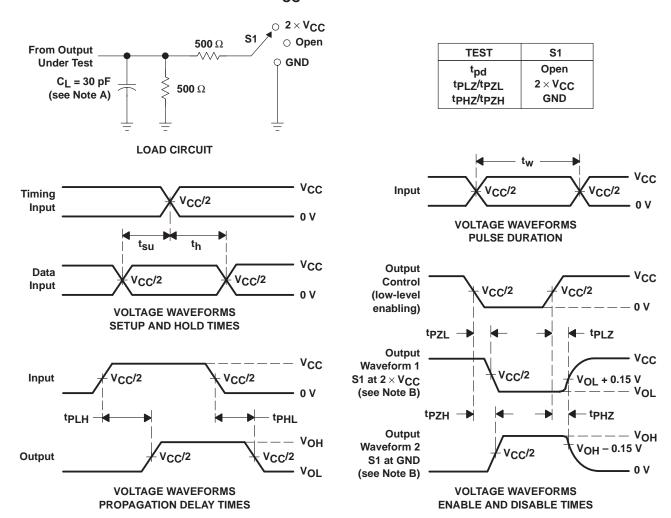
NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq 2$  ns,  $t_f \leq 2$  ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tplH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



## PARAMETER MEASUREMENT INFORMATION $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$

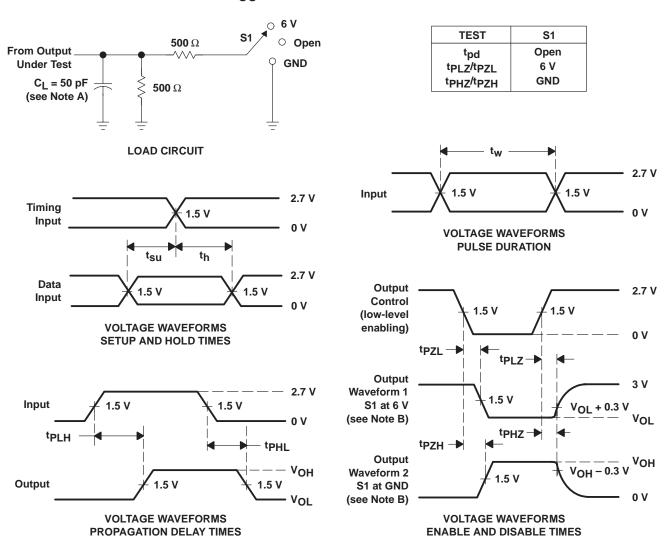


NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq 2$  ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 2. Load Circuit and Voltage Waveforms

## PARAMETER MEASUREMENT INFORMATION $V_{CC}$ = 2.7 V AND 3.3 V $\pm$ 0.3 V



NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq$  2.5 ns.  $t_f \leq$  2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpl 7 and tpH7 are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 3. Load Circuit and Voltage Waveforms



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